

05-11-2001

PATENT APPLICATION
Attorney's Do. No. 9898-170



IN THE UNITED

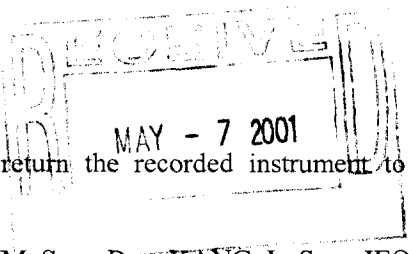
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BOX ASSIGNMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

5-7-01



Please record the attached original document or copy thereof and return the recorded instrument to the undersigned.

1. Name of party(ies) conveying an interest: Hyun-Seok LIM, Sang-Bom KANG, In-Sang JEON and Gil-Heyun CHOI

2. Name and address of party(ies) receiving an interest: Samsung Electronics Co., Ltd.
416 Maetan-dong, Paldal-ku, Suwon-City
Kyungki-do KOREA

3. Description of the interest conveyed:
 Assignment Change of Name Security Agreement Merger

Date of execution of attached document: April 2, 2001 and April 6, 2001

4. Application number(s) or patent number(s). Additional sheet attached? Yes ___ No ___

If this document is being filed together with a new application, the execution date of the application is: January 19, 2001

A. Patent Application No. 09/765,531, filed January 19, 2001
B. Patent No.

5. Name and address of party to whom correspondence concerning document should be mailed:

MARGER JOHNSON & McCOLLOM, P.C.
1030 S.W. Morrison Street
Portland, Oregon 97205
Telephone: (503) 222-3613

6. Number of applications and patents involved: 1

7. Enclosed is our check for \$40.00

8. Any deficiency or overpayment should be charged or credited to deposit account number 13-1703.

9. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Dated: May 2, 2001

05/11/2001 6T0N11 00000160 09765531
01 FC:581 40.00 0P

Respectfully submitted,
MARGER JOHNSON & McCOLLOM, P.C.

Alan T. McCollom
Reg. No. 28,881

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Total number of pages comprising
cover sheet and attached assignment: 3

ASSIGNMENT

U.S.A. Patent Application
Sole or Joint
For Inventions Made Outside U.S.A.
Executed With Application

In consideration of the sum of Ten Dollars (10.00) and other good and valuable considerations paid to each of the undersigned, to wit:

- (1) **Hyun-Seok LIM**
- (2) **Sang-Bom KANG**
- (3) **In-Sang JEON**
- (4) **Gil-Heyun CHOI**

X if continued on separate page

the receipt and sufficiency of which are hereby acknowledged by the undersigned who hereby sell(s), assign(s) and transfer(s) unto:

SAMSUNG ELECTRONICS CO., LTD.
416 MAETAN-DONG, PALDAL-KU
SUWON-CITY, KYUNGKI-DO
REPUBLIC OF KOREA

(hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States Of America as defined in 35 U.S.C. §1.00, in and to the invention known as:

**METHOD OF FORMING METAL NITRIDE FILM BY CHEMICAL VAPOR
DEPOSITION AND METHOD OF FORMING METAL CONTACT AND
CAPACITOR OF SEMICONDUCTOR DEVICE USING THE SAME**

for which an application for Letters Patent of the United States of America filed on January 19, 2001, Serial Number 09/765,531 has been executed herewith by the undersigned, and in and to any and all divisionals, continuations, substitutes, and reissues thereof; and all resulting patents and the undersigned hereby authorizes and requests the United States Assistant Commissioner of Patents to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

And the undersigned hereby agrees to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE'S full protection and title in and to the invention hereby transferred.